

18 February 2005

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**Report from the Bologna Working Group on Qualifications Frameworks**

The Bologna Working Group on Qualification Frameworks established by the Bologna Follow Up Group in March 2004 has now finalised its work and the result: a report on “A Framework for Qualifications of the European Higher Education Area” is attached to this letter.

The report provides a proposal for an overarching Framework for Qualifications of the European Higher Education Area, a proposal on criteria and procedures for articulating national qualifications frameworks towards the framework for EHEA and offers advice on good practice to facilitate the creation of new national frameworks of qualifications.

It builds on the assumption that qualifications are primarily a matter of national concern and are articulated in national qualification frameworks and that such frameworks can be inter-connected through linkage to the overarching framework of EHEA.

A draft report was discussed at a Bologna Seminar in Copenhagen on 13-14 January 2005. The comments and suggestions from the seminar mainly concerning the role of quality assurance and the procedure for verification of compatibility of national frameworks with the framework of EHEA are now included in the final report.

The Working Group recommends for the consideration of the Bologna Follow Up Group that the Bologna Ministerial Conference in Bergen adopts

- The proposal on a Framework for Qualifications of the European Higher Education Area

- The proposal on criteria and procedures for verification of compatibility of national frameworks with the framework of EHEA
- The recommendation that all signatories will complete the verification procedure by 2010

Sincerely,

Mogens Berg  
Chairman of the Working Group

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